Title		Notification Date: February 15, 2	.023
	Datasheet for DS90UB954-Q1 and DS90UI	B936-Q1	
Cust	omer Contact: Notification Manager	Dept: Quality Serv	/ices
Char	ge Type: Electrical Specification		
)es(ription of Change:		
	s Instruments Incorporated is announcing an ir	nformation only notification.	
	product datasheet(s) is being updated as sum		
	ollowing change history provides further detail		
	Texas	DS90UB	
_	INSTRUMENTS	SNLS570C - AUGUST 2017 - REVISED JANU/	ARY 2023
Ch	anges from Revision B (December 2018) to Revision	C (January 2023)	Page
	Jpdated the numbering format for tables, figures, and cr		
	Changed all instances of legacy terminology to controlle		
	Revised the PDB pin voltage for normal operation		
	Changed the VDD11 pin descriptions for clarity		
	Added a link to Design Requirements under the RIN pins Jpdated the V _{IH} and V _{IL} specifications of pins PDB, XIN		
	Removed the mention of CSI-2 non-synchronous clockir		
	Changed the bits that need to be modified for Clock Mod		
	Changed the names of registers CAM_INT_RISE_STS		
	and SEN_INT_FALL_STS		35
	Removed the mention of setting the REF_CLK_MODE b		
	Fixed typos in the internal FrameSync calculations		
	Rewrote the basic synchronized forwarding code examp		
	Added in that V_{VDDIO} must match V_{I2C}		
	Removed the mention of 'PDB' from register 0x0D Changed BCC_Config Register[2:0] binary setting value		
	Changed PORT_CONFIG2[5] default value to 0x1		
	Changed suggested ferrite beads for 4G FPD-Link PoC		
	Changed PoC network impedance recommendation from		
•	Jpdated the PoC description		140
	Removed the insertion and return loss values from the ta		
	PCB Traces With Attached PoC Networks		
	Changed the value of the capacitor for pin VDD11_CSI f		
	HIGH		
	Moved the additional notes in the typical application diag		
• 4	dded a note to clarify the power-up sequence between		1/0
	emoved T0 and T2 from power-up sequence		
	dded a note to clarify that a hard reset is optional in the		
• /	dded in T7, the PDB to I2C ready delay, to the power-u	ip sequence	149
	hanged the pull-up resistor for PDB from 33-k Ω to 10-k		



DS90UB936-Q1 SNLS571C – MARCH 2018 – REVISED JANUARY 2023

С	hanges from Revision B (June 2018) to Revision C (January 2023)	Page
•	Updated the numbering format for tables, figures, and cross-references throughout the document	1
•	Changed all instances of legacy terminology to controller and target	
•	Updated the list of compatible devices to include the DS90UB953-Q1	
•	Revised the PDB pin voltage for normal operation	
•	Changed the VDD11 pin descriptions for clarity	
•	Added a link to Design Requirements under the RIN pins	4
•	Updated the VIH and VIL specifications of pins PDB, XIN/REFCLK, and VDD_SEL	10
•	Removed the mention of CSI-2 non-synchronous clocking mode	
•	Changed the bits that need to be modified for Clock Mode	
•	Removed the mention of setting the REF_CLK_MODE bit as it is a reserved bit	
•	Fixed typos in the internal FrameSync calculations	
•	Rewrote the basic synchronized forwarding code example to set both sensors to use CSI-2 serializer	
•	Added in that V _{VDDIO} must match V _{I2C}	54
•	Removed the mention of 'PDB' from register 0x0D	75
•	Changed BCC_Config Register[2:0] binary setting value 0b111 to reserved	
•	Changed PORT_CONFIG2[5] default value to 0x1	
•	Changed suggested ferrite beads for 4G FPD-Link PoC Network from 1500 kΩ to 1.5 kΩ	139
•	Changed PoC network impedance recommendation from 2kΩ to 1kΩ	139
•	Updated the PoC description	
•	Removed the insertion and return loss values from the table on Suggested Characteristics for Single	-Ended
	PCB Traces With Attached PoC Networks	139
•	Added a note to explain the differences between the decoupling capacitors	143
•	Changed the value of the capacitor for pin VDD11_CSI from 1-µF to 10-µF in the diagram where VDI	D_SEL =
	HIGH	
•	Moved the additional notes in the typical application diagram from the picture to below the diagram	143
•	Added a note to clarify the power-up sequence between VDD18 and VDDIO	148
•	Removed T0 and T2 from power-up sequence	
•	Added a note to clarify that a hard reset is optional in the power-up sequence	
•	Added in T7, the PDB to I2C ready delay, to the power-up sequence	
•	Changed the pull-up resistor for PDB from 33-k Ω to 10-k Ω	

The datasheet number will be changing.

Device Family	Change From:	Change To:
DS90UB954-Q1	SNLS570B	SNLS570C
DS90UB936-Q1	SNLS571B	SNLS571C

The document is not available on the TI website. Please access MySecure for a copy of the full datasheet.

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this notification:

None.

Product Affected:									
DS90UB954TRGZRQ1	DS90UB954TRGZTQ1	DS90UB936TRGZRQ1	DS90UB936TRGZTQ1						

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail	
WW Change Management Team	<u>PCN ww admin team@list.ti.com</u>	

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